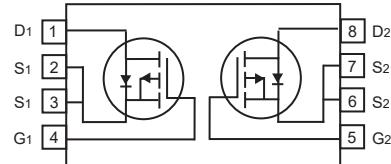


**Dual P-Channel Enhancement Mode Field Effect Transistor****FEATURES**

- -30V, -6.4A,  $R_{DS(ON)} = 19m\Omega$  @ $V_{GS} = -10V$ .
- $R_{DS(ON)} = 31m\Omega$  @ $V_{GS} = -4.5V$ .
- Super High dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handing capability.
- Pb-free lead plating ; RoHS compliant.
- Halogen Free.
- TSSOP-8 for Surface Mount Package.

**ABSOLUTE MAXIMUM RATINGS**  $T_A = 25^\circ C$  unless otherwise noted

| Parameter                             | Symbol         | Limit      | Units      |
|---------------------------------------|----------------|------------|------------|
| Drain-Source Voltage                  | $V_{DS}$       | -30        | V          |
| Gate-Source Voltage                   | $V_{GS}$       | $\pm 20$   | V          |
| Drain Current-Continuous              | $I_D$          | -6.4       | A          |
| Drain Current-Pulsed <sup>a</sup>     | $I_{DM}$       | -25.6      | A          |
| Maximum Power Dissipation             | $P_D$          | 1.25       | W          |
| Operating and Store Temperature Range | $T_J, T_{stg}$ | -55 to 150 | $^\circ C$ |

**Thermal Characteristics**

| Parameter                               | Symbol          | Limit | Units        |
|---|-----------------|-------|--------------|
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 100   | $^\circ C/W$ |



# CEG3137D

## Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

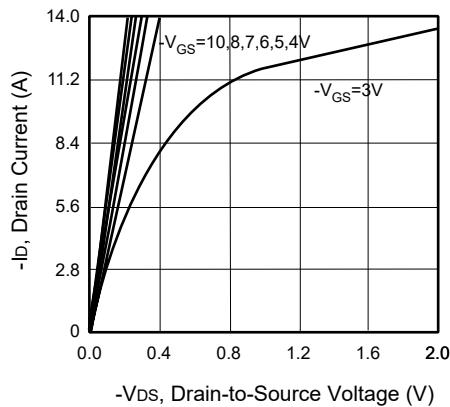
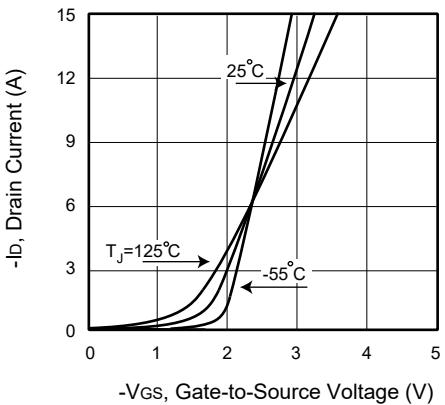
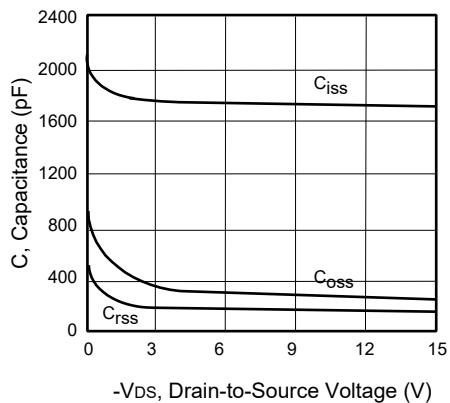
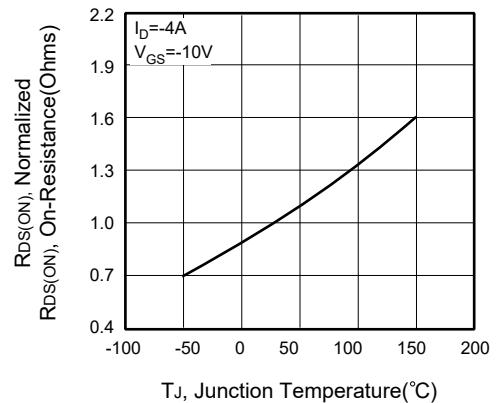
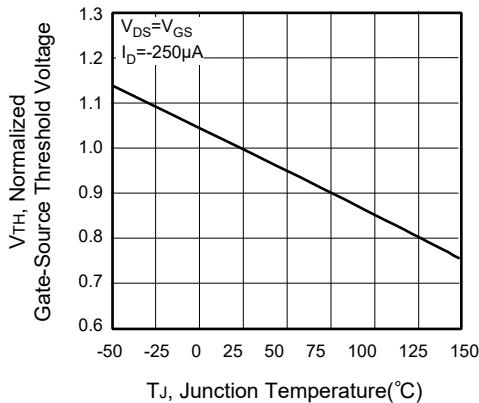
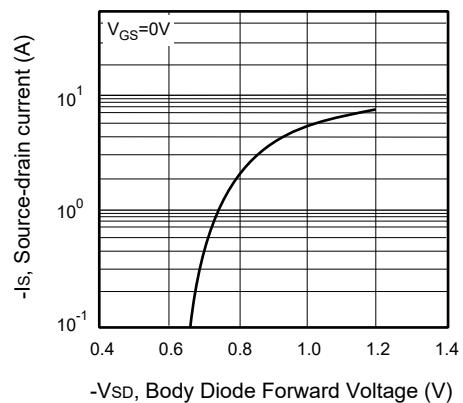
| Parameter   | Symbol                     | Test Condition  | Min  | Typ  | Max  | Units            |
|---|----------------------------|---|------|------|------|------------------|
| <b>Off Characteristics</b>                                    |                            |   |      |      |      |                  |
| Drain-Source Breakdown Voltage                                | $\text{BV}_{\text{DSS}}$   | $V_{\text{GS}} = 0\text{V}, I_{\text{D}} = -250\mu\text{A}$   | -30  |      |      | V                |
| Zero Gate Voltage Drain Current                               | $I_{\text{DSS}}$           | $V_{\text{DS}} = -30\text{V}, V_{\text{GS}} = 0\text{V}$  |      |      | -1   | $\mu\text{A}$    |
| Gate Body Leakage Current, Forward                            | $I_{\text{GSSF}}$          | $V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$   |      |      | 100  | nA               |
| Gate Body Leakage Current, Reverse                            | $I_{\text{GSSR}}$          | $V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$  |      |      | -100 | nA               |
| <b>On Characteristics<sup>b</sup></b>                         |                            |   |      |      |      |                  |
| Gate Threshold Voltage  | $V_{\text{GS}(\text{th})}$ | $V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = -250\mu\text{A}$   | -0.8 |      | -2   | V                |
| Static Drain-Source On-Resistance                             | $R_{\text{DS}(\text{on})}$ | $V_{\text{GS}} = -10\text{V}, I_{\text{D}} = -4\text{A}$  |      | 16   | 19   | $\text{m}\Omega$ |
|   |                            | $V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -2\text{A}$   |      | 24   | 31   | $\text{m}\Omega$ |
| <b>Dynamic Characteristics<sup>c</sup></b>                    |                            |   |      |      |      |                  |
| Input Capacitance   | $C_{\text{iss}}$           | $V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$                                   |      | 1710 |      | pF               |
| Output Capacitance  | $C_{\text{oss}}$           |   |      | 260  |      | pF               |
| Reverse Transfer Capacitance                                  | $C_{\text{rss}}$           |   |      | 185  |      | pF               |
| <b>Switching Characteristics<sup>c</sup></b>                  |                            |   |      |      |      |                  |
| Turn-On Delay Time  | $t_{\text{d}(\text{on})}$  | $V_{\text{DD}} = -24\text{V}, I_{\text{D}} = -1\text{A}, V_{\text{GS}} = -10\text{V}, R_{\text{GEN}} = 6\Omega$ |      | 16   |      | ns               |
| Turn-On Rise Time   | $t_r$                      |   |      | 8    |      | ns               |
| Turn-Off Delay Time   | $t_{\text{d}(\text{off})}$ |   |      | 75   |      | ns               |
| Turn-Off Fall Time  | $t_f$                      |   |      | 36   |      | ns               |
| Total Gate Charge   | $Q_g$                      | $V_{\text{DS}} = -24\text{V}, I_{\text{D}} = -1\text{A}, V_{\text{GS}} = -4.5\text{V}$                          |      | 18   |      | nC               |
| Gate-Source Charge  | $Q_{\text{gs}}$            |   |      | 3.4  |      | nC               |
| Gate-Drain Charge   | $Q_{\text{gd}}$            |   |      | 7.1  |      | nC               |
| <b>Drain-Source Diode Characteristics and Maximum Ratings</b> |                            |   |      |      |      |                  |
| Drain-Source Diode Forward Current                            | $I_S$                      |   |      |      | -1   | A                |
| Drain-Source Diode Forward Voltage <sup>b</sup>               | $V_{\text{SD}}$            | $V_{\text{GS}} = 0\text{V}, I_S = -1\text{A}$   |      |      | -1.2 | V                |

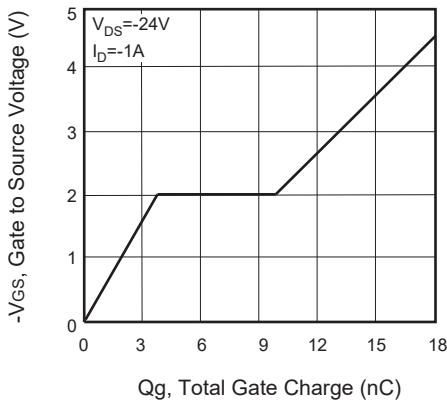
Notes :

a.Repetitive Rating : Pulse width limited by maximum junction temperature.

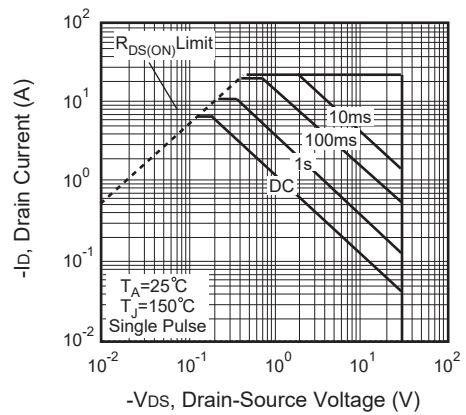
b.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ . Duty Cycle  $\leq 2\%$ .

c.Guaranteed by design, not subject to production testing.

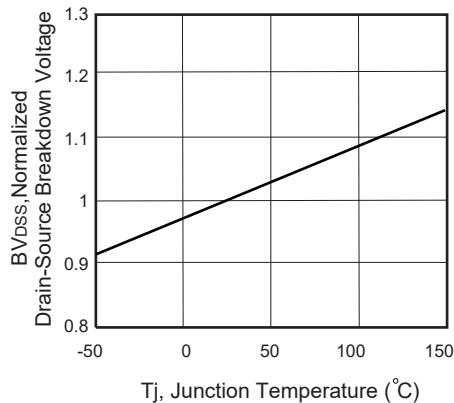
**Figure 1. Output Characteristics****Figure 2. Transfer Characteristics****Figure 3. Capacitance****Figure 4. On-Resistance Variation with Temperature****Figure 5. Gate Threshold Variation with Temperature****Figure 6. Body Diode Forward Voltage Variation with Source Current**



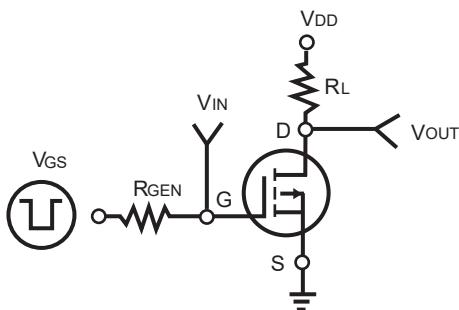
**Figure 7. Gate Charge**



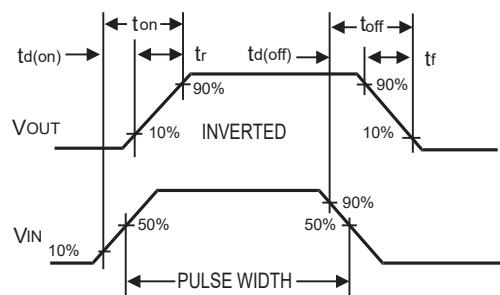
**Figure 8. Maximum Safe Operating Area**



**Figure 9. Breakdown Voltage Variation VS Temperature**



**Figure 10. Switching Test Circuit**



**Figure 11. Switching Waveforms**

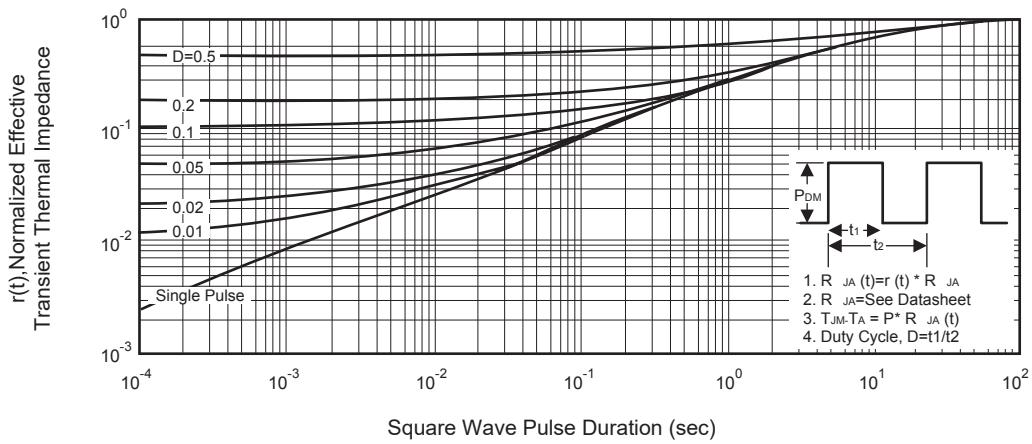


Figure 12. Normalized Thermal Transient Impedance Curve